



Atty Docket No. 042390.P17299

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of: Peter Tolchinsky et al. Application No.: 10/661,738 Filed: September 11, 2003 For: METHODS AND APPARATUSES FRO MANUFACTURING ULTRA THIN DEVICE LAYERS FOR INTEGRATED CIRCUIT DEVICES	Examiner: Luan C. Thai Art Unit: 2891 Confirmation No.: 8287
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MAIL STOP NON-FEE AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

AMENDMENT AND RESPONSE TO OFFICE ACTION

Sir:

In response to the Office Action mailed October 19, 2005, please enter the following amendment.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450 on 2/21/06

Vanessa Sanchez

(Typed or printed name of person mailing correspondence)

Vanessa Sanchez

(Signature of person mailing correspondence)